

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IPP100N08S2L-07	**Issued**	24. February 2022
MA#	MA005699695		
Package	PG-TO220-3-1	**Weight***	2042.91 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	12.294	0.60	0.60	6018	6018
leadframe	inorganic material	phosphorus	7723-14-0	0.245	0.01		120	
	non noble metal	iron	7439-89-6	0.816	0.04		400	
	non noble metal	copper	7440-50-8	815.335	39.93	39.98	399103	399623
wire	non noble metal	aluminium	7429-90-5	9.880	0.48	0.48	4836	4836
encapsulation	inorganic material	zincoxide	1314-13-2	5.846	0.29		2862	
	miscellaneous	miscellaneous	-	23.385	1.14		11447	
	plastics	epoxy resin	-	87.695	4.29		42926	
	inorganic material	silicondioxide	60676-86-0	467.705	22.89	28.61	228940	286175
leadfinish	non noble metal	tin	7440-31-5	21.462	1.05	1.05	10506	10506
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.244	0.01	0.01	119	120
solder	non noble metal	tin	7440-31-5	0.155	0.01		76	
	noble metal	silver	7440-22-4	0.194	0.01		95	
	non noble metal	lead	7439-92-1	7.423	0.36	0.38	3634	3805
heatspreader	inorganic material	phosphorus	7723-14-0	0.177	0.01		87	
	non noble metal	iron	7439-89-6	0.590	0.03		289	
	non noble metal	copper	7440-50-8	589.466	28.85	28.89	288541	288917
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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